



THE DATASHEET OF MUR1640CTG



MUR1610CTG, MUR1615CTG, MUR1620CTG, MUR1640CTG, MUR1660CTG

Switch Mode Power Rectifiers

These state-of-the-art devices are a series designed for use in switching power supplies, inverters and as free wheeling diodes.

Features

- Ultrafast 35 and 60 Nanosecond Recovery Times
- 175°C Operating Junction Temperature
- Popular TO-220 Package
- Epoxy Meets UL 94 V-0 @ 0.125 in
- High Temperature Glass Passivated Junction
- High Voltage Capability to 600 V
- Low Leakage Specified @ 150°C Case Temperature
- Current Derating @ Both Case and Ambient Temperatures
- These are Pb-Free Devices*

Mechanical Characteristics:

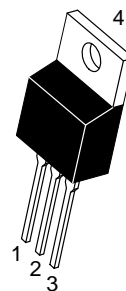
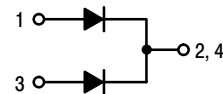
- Case: Epoxy, Molded
- Weight: 1.9 Grams (Approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes:
260°C Max. for 10 Seconds



ON Semiconductor®

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ULTRAFAST RECTIFIERS 16 AMPERES, 100-600 VOLTS



TO-220AB
CASE 221A-09

MARKING DIAGRAM



- A = Assembly Location
- Y = Year
- WW = Work Week
- U16xx = Device Code
xx = 10, 15, 20, 40 or 60
- G = Pb-Free Package
- KA = Diode Polarity

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 6 of this data sheet.

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MAXIMUM RATINGS

| Rating | Symbol | MUR16 | | | | | Unit |
|--|--|-------------|------|------|------|------|------------------|
| | | 10CT | 15CT | 20CT | 40CT | 60CT | |
| Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage | V_{RRM} V_{RWM} V_R | 100 | 150 | 200 | 400 | 600 | V |
| Average Rectified Forward Current Total Device, (Rated V_R), $T_C = 150^\circ\text{C}$ | $I_{F(AV)}$ Per Leg Total Device | 8.0 16 | | | | | A |
| Peak Rectified Forward Current (Rated V_R , Square Wave, 20 kHz), $T_C = 150^\circ\text{C}$ | I_{FM} Per Diode Leg | 16 | | | | | A |
| Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz) | I_{FSM} | 100 | | | | | A |
| Operating Junction Temperature and Storage Temperature | T_J, T_{stg} | -65 to +175 | | | | | $^\circ\text{C}$ |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL CHARACTERISTICS (Per Diode Leg)

| Parameter | Symbol | Value | | Unit |
|--|-----------------|-------|-----|--------------------|
| Maximum Thermal Resistance, Junction-to-Case | $R_{\theta JC}$ | 3.0 | 2.0 | $^\circ\text{C/W}$ |

ELECTRICAL CHARACTERISTICS (Per Diode Leg)

| Characteristic | Symbol | 1620 | 1640 | 1660 | Unit |
|--|----------|----------------|--------------|--------------|---------------|
| Maximum Instantaneous Forward Voltage (Note 1) ($I_F = 8.0\text{ A}$, $T_C = 150^\circ\text{C}$) ($I_F = 8.0\text{ A}$, $T_C = 25^\circ\text{C}$) | V_F | 0.895 0.975 | 1.00 1.30 | 1.20 1.50 | V |
| Maximum Instantaneous Reverse Current (Note 1) (Rated DC Voltage, $T_C = 150^\circ\text{C}$) (Rated DC Voltage, $T_C = 25^\circ\text{C}$) | i_R | 250 5.0 | 500 10 | | μA |
| Maximum Reverse Recovery Time ($I_F = 1.0\text{ A}$, $di/dt = 50\text{ A}/\mu\text{s}$) ($I_F = 0.5\text{ A}$, $I_R = 1.0\text{ A}$, $I_{REC} = 0.25\text{ A}$) | t_{rr} | 35 25 | 60 50 | | ns |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

1. Pulse Test: Pulse Width = 300 μs , Duty Cycle $\leq 2.0\%$

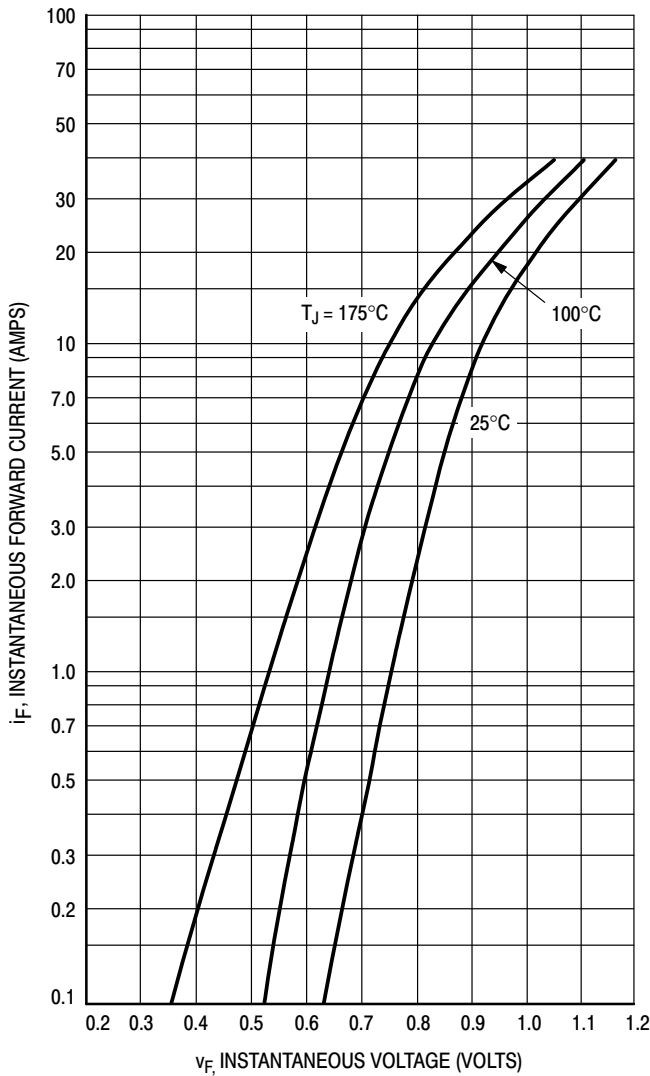


Figure 1. Typical Forward Voltage, Per Leg

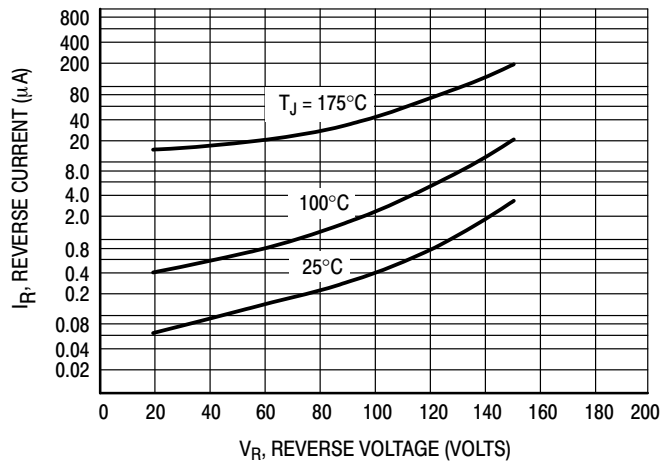


Figure 2. Typical Reverse Current, Per Leg*

* The curves shown are typical for the highest voltage device in the voltage grouping. Typical reverse current for lower voltage selections can be estimated from these same curves if V_R is sufficiently below rated V_R .

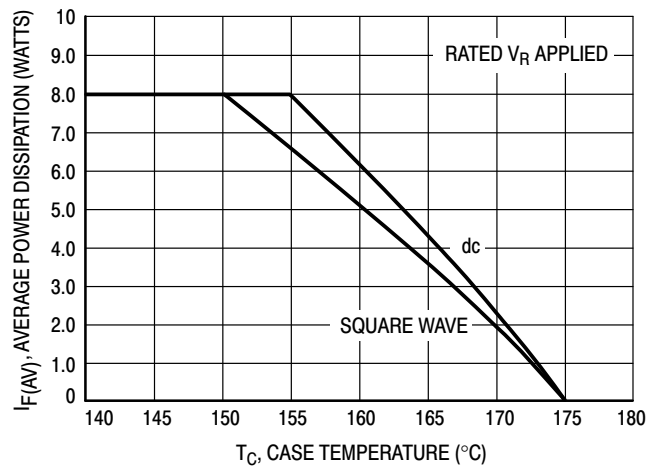


Figure 3. Current Derating, Case, Per Leg

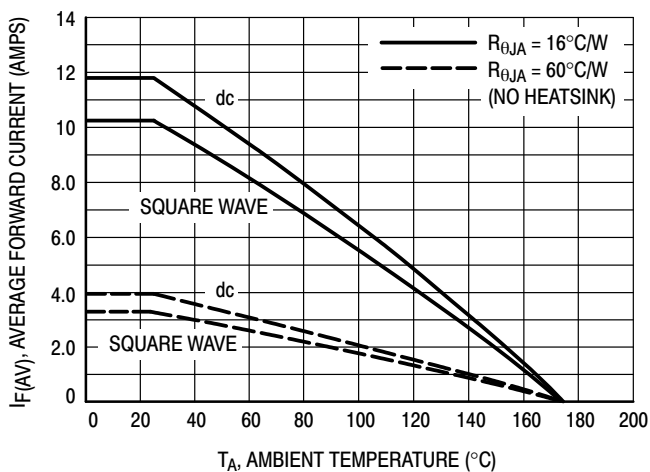


Figure 4. Current Derating, Ambient, Per Leg

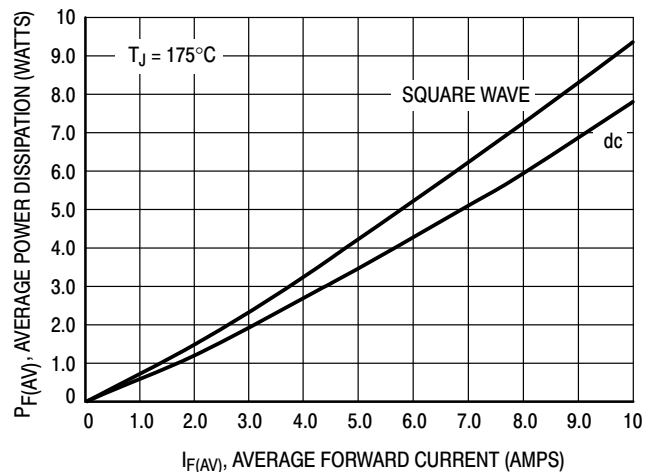


Figure 5. Power Dissipation, Per Leg

MUR1640CT

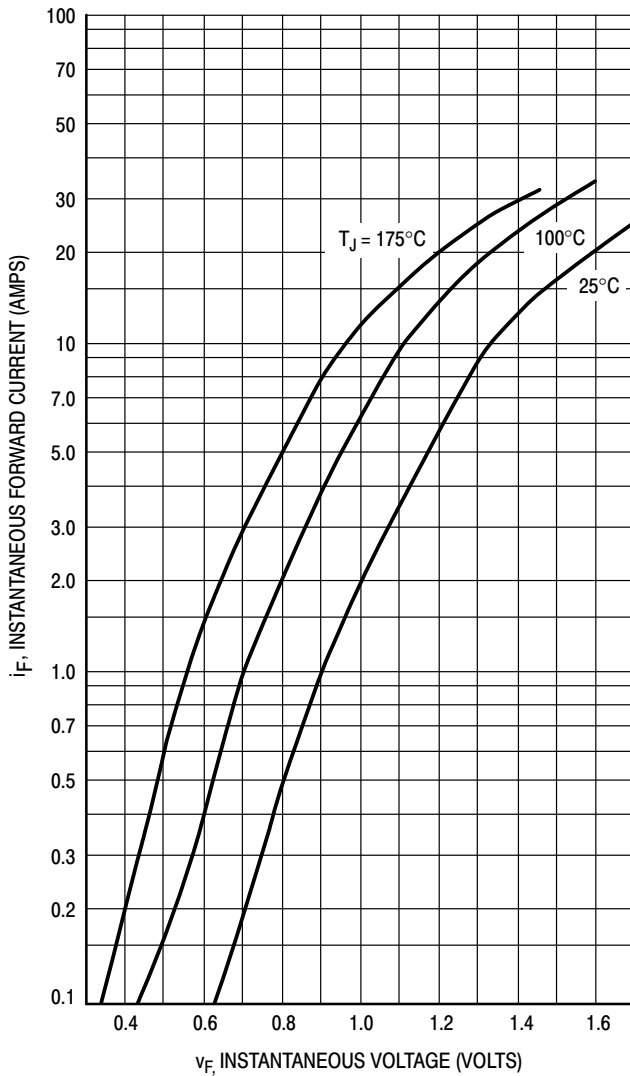


Figure 6. Typical Forward Voltage, Per Leg

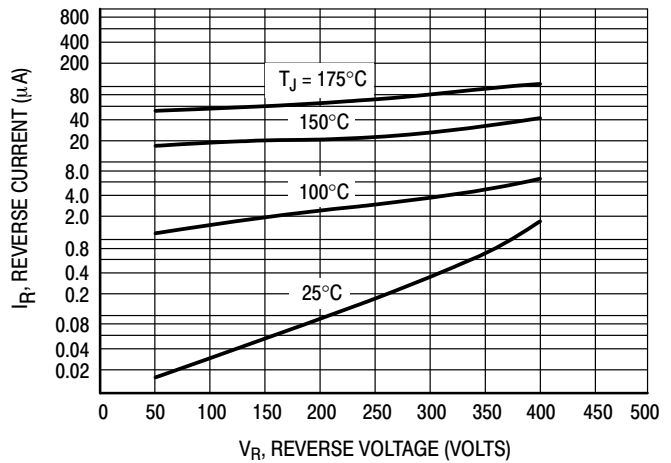


Figure 7. Typical Reverse Current, Per Leg*

* The curves shown are typical for the highest voltage device in the voltage grouping. Typical reverse current for lower voltage selections can be estimated from these curves if V_R is sufficiently below rated V_R .

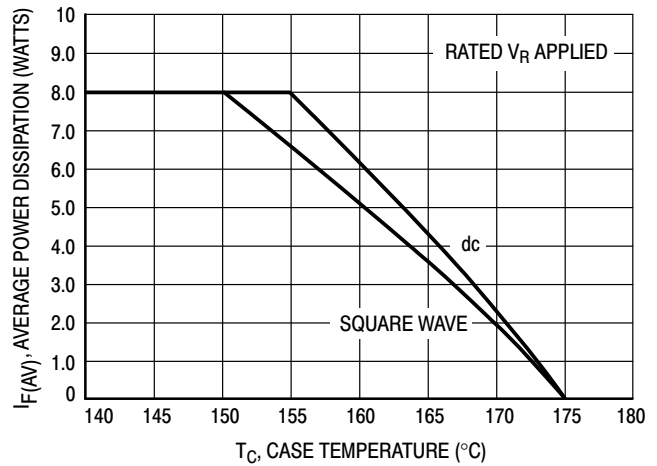


Figure 8. Current Derating, Case, Per Leg

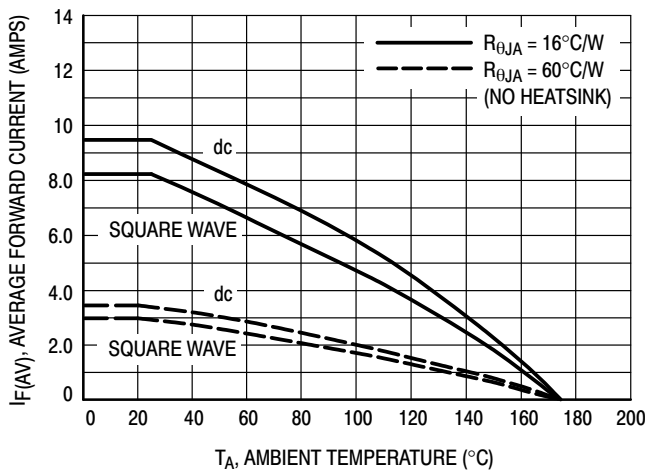


Figure 9. Current Derating, Ambient, Per Leg

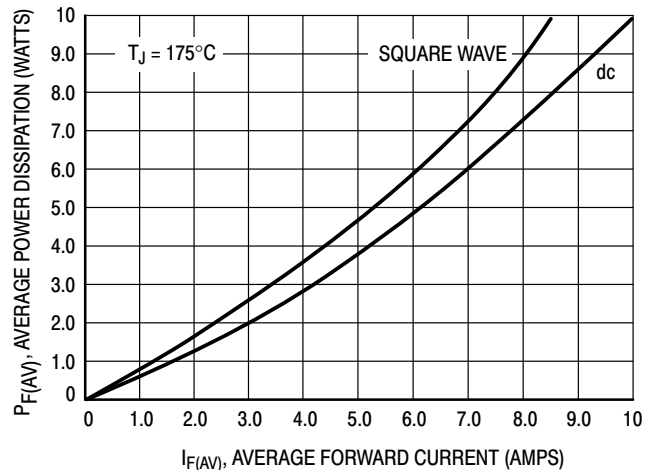


Figure 10. Power Dissipation, Per Leg

MUR1660CT

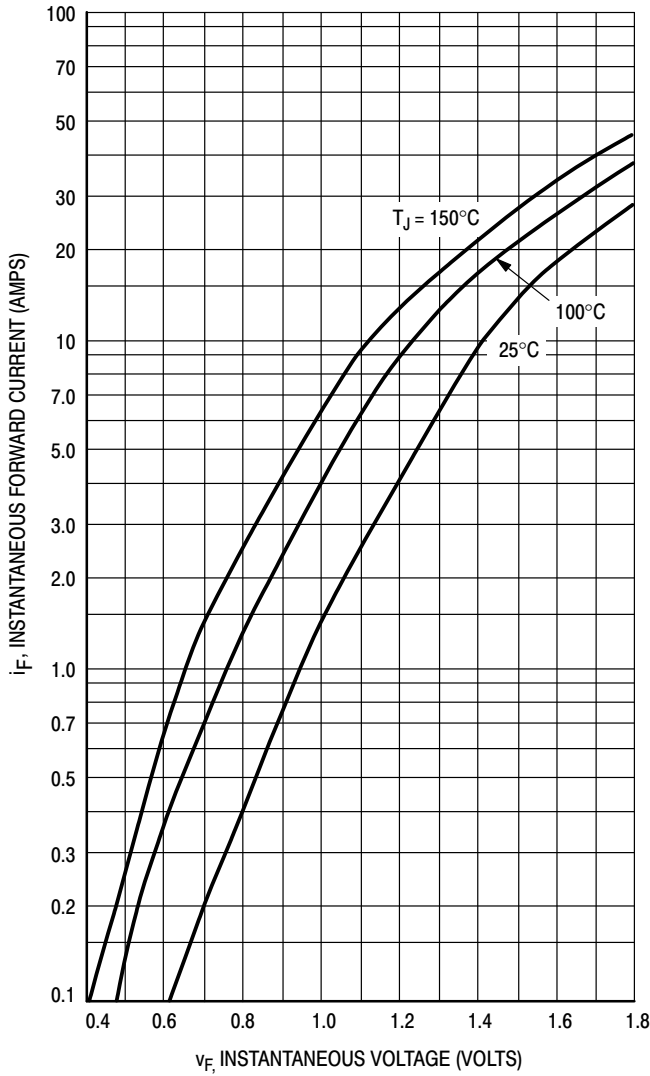


Figure 11. Typical Forward Voltage, Per Leg

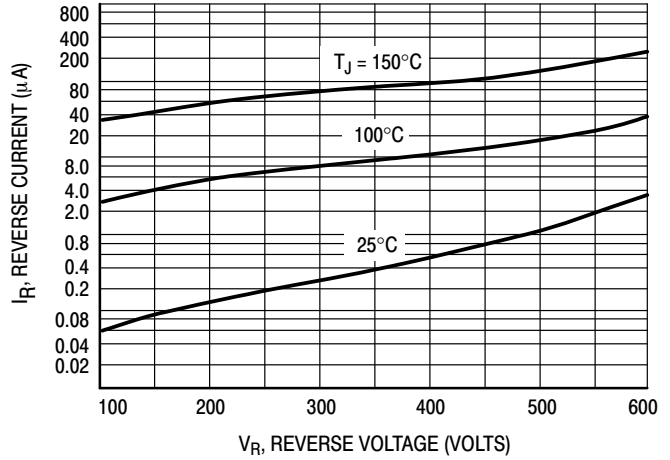


Figure 12. Typical Reverse Current, Per Leg*

* The curves shown are typical for the highest voltage device in the voltage grouping. Typical reverse current for lower voltage selections can be estimated from these same curves if V_R is sufficiently below rated V_R .

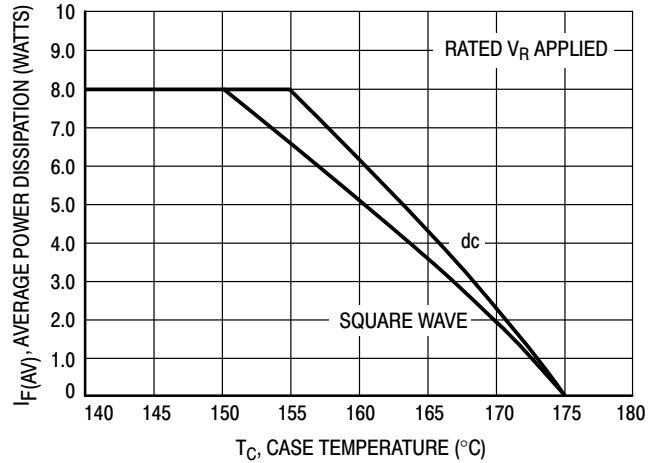


Figure 13. Current Derating, Case, Per Leg

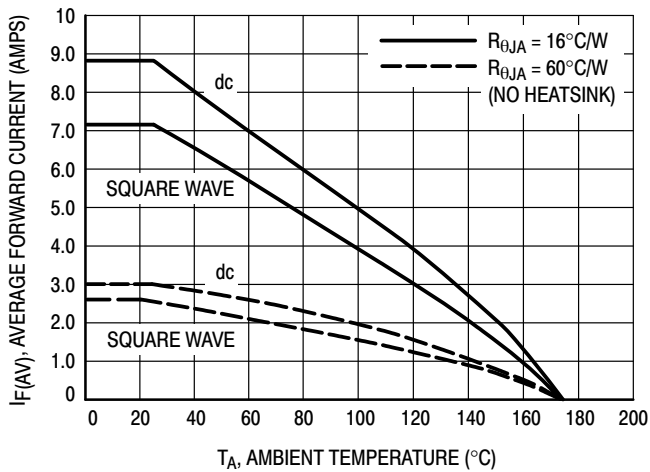


Figure 14. Current Derating, Ambient, Per Leg

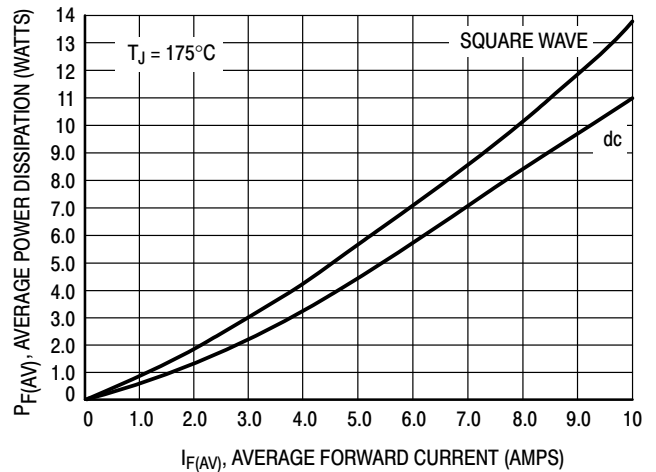


Figure 15. Power Dissipation, Per Leg

MUR1610CTG, MUR1615CTG, MUR1620CTG, MUR1640CTG, MUR1660CTG

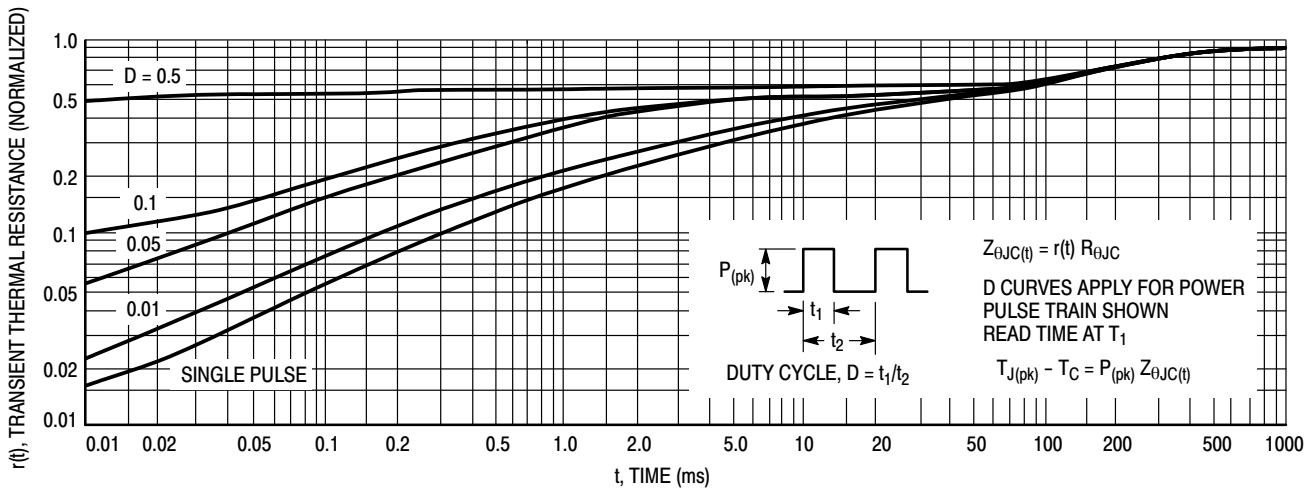


Figure 16. Thermal Response

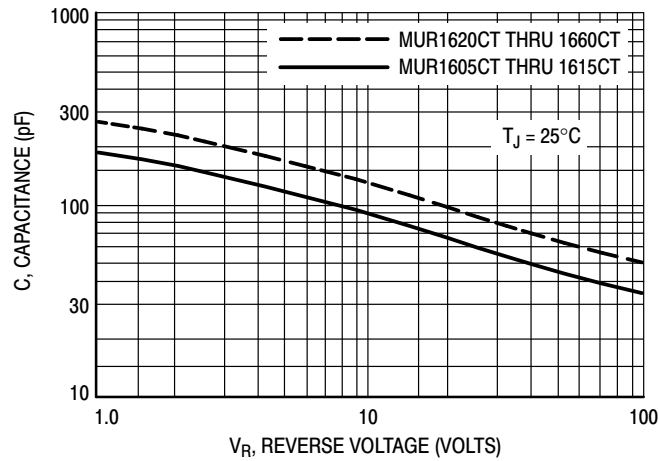


Figure 17. Typical Capacitance, Per Leg

ORDERING INFORMATION

| Device | Package | Shipping† |
|------------|---------------------|-----------------|
| MUR1610CTG | TO-220 (Pb-Free) | 50 Units / Rail |
| MUR1615CTG | TO-220 (Pb-Free) | |
| MUR1620CTG | TO-220 (Pb-Free) | |
| MUR1640CTG | TO-220 (Pb-Free) | |
| MUR1660CTG | TO-220 (Pb-Free) | |

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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